

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT2861568

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	G. GLENN HENRY	05/09/2014
	TERRY PARKS	05/09/2014
RECEIVING PARTY DATA		
Name:	VIA TECHNOLOGIES, INC.	
Street Address:	8F, 533, ZHONGZHENG RD., XINDIAN DISTRICT	
City:	NEW TAIPEI CITY	
State/Country:	TAIWAN	
Postal Code:	231	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	14281488
CORRESPONDENCE DATA		
Fax Number:	(719)623-0141	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
Phone:	719-475-7103	
Email:	PTOHLG@me.com	
Correspondent Name:	HUFFMAN LAW GROUP, P.C.	
Address Line 1:	7702 BARNES RD., STE. 140-46	
Address Line 4:	COLORADO SPRINGS, COLORADO 80922	
ATTORNEY DOCKET NUMBER:	CNTR.2639	
NAME OF SUBMITTER:	TAYSIE J. LOCKE	
SIGNATURE:	/Taysie J. Locke/	
DATE SIGNED:	05/19/2014	
	This document serves as an Oath/Declaration (37 CFR 1.63).	
Total Attachments: 2		
source=CNTR-2639_DecAssignment#page1.tif		
source=CNTR-2639_DecAssignment#page2.tif		

**DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN
APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT FOR SINGLE
ASSIGNEE**

TITLE OF INVENTION	CORE SYNCHRONIZATION MECHANISM IN A MULTI-DIE MULTI-CORE MICROPROCESSOR
---------------------------	--

This is a combined declaration and assignment by the inventor(s) named below to the assignee named below.

I. Declaration and Related Statements

As a below named inventor, I hereby declare that:

This declaration is directed to:

The attached application; or

United States application or PCT International application number _____
filed on _____.

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

II. Assignment

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made, the said application having been executed on even date herewith;

AND WHEREAS, **VIA TECHNOLOGIES, INC.** together with any successors, legal representatives, or assigns thereof, with its principal office at **8F, 533, Zhongzheng Road, Xindian District, New Taipei City 231, Taiwan**, wants to acquire the entire right, title and interest in and to the said invention(s), and to the said application and any Letters Patent that may issue thereon;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I have sold, assigned, transferred and set over, and do hereby sell, assign, transfer and set over to the said **VIA TECHNOLOGIES, INC.**, its successors and assigns, the entire right, title and interest in and to the said invention and in and to the said application and all patents which may be granted thereon, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I/we hereby authorize and request the Commissioner of Patents, and any officials of foreign countries whose duty it is to issue patents on applications, to issue all patents for said invention, or patents resulting therefrom, insofar as my interest in concerned, to the said **VIA TECHNOLOGIES, INC.** as assignee of my entire right, title and interest;

I ALSO HEREBY sell and assign to **VIA TECHNOLOGIES, INC.**, its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any

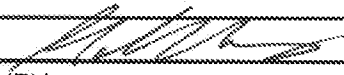
other papers in connection therewith necessary to perfect such patent rights;

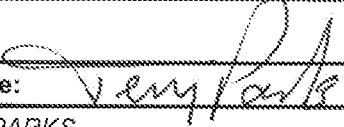
AND I HEREBY covenant that I have full right to convey the entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith;

AND I HEREBY further covenant that I will communicate to said VIA TECHNOLOGIES, INC., or to its successors, assigns and legal representatives, any facts known to me respecting said invention, and at the expense of said VIA TECHNOLOGIES, INC., testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said VIA TECHNOLOGIES, INC., its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

III. Signatures

A. Inventors

Signature: 	Date: 5-9-14
G. GLENN HENRY	

Signature: 	Date: 5-9-14
TERRY PARKS	

Huffman Law Group, P.C.
Attorneys at Law
Customer No. 23669
7702 Barnes Rd., Ste 140-46
Colorado Springs CO 80922